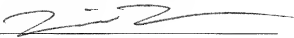


I hereby certify that this correspondence is being electronically transmitted to the United States Patent and Trademark Office on the date shown below:

AMENDMENT UNDER 37 CFR §1.111
Patent Application
Docket No. P1.128

October 28, 2008


Louis C. Frank, Patent Attorney

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner : Michael A. Marcheschi
Art Unit : 1793
Applicant : Hyun Soo Roh *et al.*
Serial No. : 10/531,125
Filed : April 11, 2005
Conf. No. : 2644
For : Slurry Composition for Secondary Polishing of Silicon Wafer

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT UNDER 37 CFR §1.111

Sir:

In response to the Office Action dated July 28, 2008, please amend the above-referenced application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks follow the amendment section.